APPENDIX A

91. (Amended) An improved method for stabilizing a spino	us process relative
to another spinous process, said method being of the type wherein a	device is
implanted between said spinous process and said another spinous p	rocess, wherein
said improvement comprises:	
introducing between said spinous process and said and	other spinous
process a device which is conformable comformable in situ to	the shape of at
least one of said spinous process and said another spinous pr	ocess.
93. (Amended) An improved method for stabilizing a spino	us process relative
to another spinous process, said method being of the type wherein a	device is
implanted between said spinous process and said another spinous p	rocess, wherein
said improvement comprises:	
introducing between said spinous process and said and	other spinous
process a device <u>having a sealable cavity</u> which is fillable with	a material.
94. (Amended) An improved method for stabilizing a spino	us process relative
to another spinous process, said method being of the type wherein a	device is
implanted between said spinous process and said another spinous p	rocess, wherein
said improvement comprises:	
introducing between said spinous process and said and	other spinous
process a device which is has flexible walls defining a <u>sealable</u>	e cavity capable of
receiving being filled with a material.	
100. (Amended) The improved method of claim 98 wherein	:
said introducing step includes using a material which ch	nanges shape
according accoridng to temperature.	
106. (Amended) The method of claim 102 further including	
a said removing step allow the device to reconfigure ab	out one of said
spinous process and said another spinous process.	

File No.: KLYC-01000USN SRM/CAS Serial No. 09/684,017 srm/klyc/1000dv2cn1/1000usn_Resp_OA_07172002

1 2

- 1 113. (Amended) An improved method for stabilizing a spinous process relative
- 2 to another spinous process, said method being of the type wherein a device is
- 3 implanted between said spinous process and said another spinous process, wherein
- 4 said improvement comprises:
- 5 introducing between the spinous process and the another spinous processes
- 6 <u>process</u> a device without altering the spinous processes.

File No.: KLYC-01000USN SRM/CAS

Serial No. 09/684,017

srm/klyc/1000dv2cn1/1000usn_Resp_OA_07172002